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November 2013



FGH80N60FD2 600 V Field Stop IGBT

Features

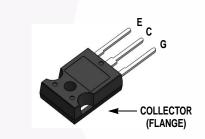
- High Current Capability
- Low Saturation Coltage: V_{CE(sat)} = 1.8 V @ I_C = 40 A
- High Input Impedance
- Fast Switching
- RoHS Compliant

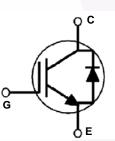
Applications

Induction Heating, PFC

General Description

Using novel field stop IGBT technology, Fairchild's field stop IGBTs offer the optimum performance for induction heating and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description			Ratings	Unit
V _{CES}	Collector-Emitter Voltage		600		V
V _{GES}	Gate-Emitter Voltage			± 20	V
la	Collector Current	@ T _C = 25°C		80	А
I ^C	Collector Current	@ T _C = 100°C		40	А
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25°C		160	А
P _D	Maximum Power Dissipation	@ T _C = 25°C		290	W
· D	Maximum Power Dissipation	@ T _C = 100°C		116	W
TJ	Operating Junction Temperature			-55 to +150	°C
T _{stg}	Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds			300	°C

Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit	
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction-to-Case		0.43	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction-to-Case		1.45	°C/W	
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W	

FGH
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Field
Stop
IGBT

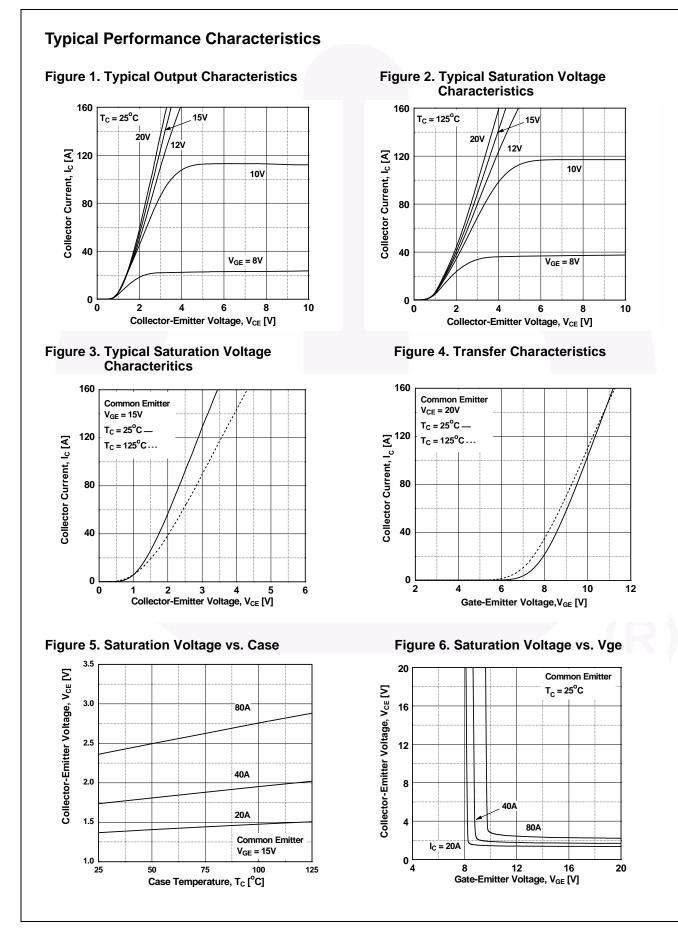
Part Number Top Mark Package FGH80N60FD2TU FGH80N60FD2 TO-247		Packing Method	Reel Size	Tape Wig	dth Q	Quantity 30		
		Tube	N/A	N/A				
Electric	al Cha	aracteristics	of the IC	BT $T_{C} = 25^{\circ}C$ unless other	wise noted			
Symbol		Parameter		Test Condition	ns Min.	Тур.	Max.	Unit
Off Charac	teristics							
BV _{CES}	Collecto	or-Emitter Breakdov	wn Voltage	V _{GE} = 0 V, I _C = 250 uA	600			V
ΔBV _{CES} / ΔΤ _J	Temperature Coefficient of Breakdown Voltage		$V_{GE} = 0 V, I_C = 250 uA$		0.6		V/°C	
	Collector Cut-Off Current		V _{CE} = V _{CES} , V _{GE} = 0 V			250	uA	
I _{GES}	G-E Lea	akage Current		$V_{GE} = V_{GES}, V_{CE} = 0 V$			±400	nA
On Charac	toriotico							
		reshold Voltage		I _C = 250 uA, V _{CE} = V _{GE}	4.5	5.5	7.0	V
V _{GE(th)}	0.5 11	Control voltage		$I_{\rm C} = 40$ A, $V_{\rm GE} = 15$ V		1.8	2.4	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage			$I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$ $I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 125^{\circ}\text{C}$		2.05		V
C _{ies} C _{oes} C _{res}	Output Capacitance Reverse Transfer Capacitance		V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz		200 60		pF pF pF	
Switching	Characte	eristics						
t _{d(on)}	1	n Delay Time				21		ns
t _r	Rise Tir	ne				56		ns
t _{d(off)}	Turn-Of	n-Off Delay Time Time		$V_{\rm CC} = 400 \text{ V}, \text{ I}_{\rm C} = 40 \text{ A},$		126		ns
t _f	Fall Tim			$R_{G} = 10 \Omega$, $V_{GE} = 15 V$,		50	100	ns
E _{on}	Turn-Or	n Switching Loss		Inductive Load, $T_C = 25^{\circ}$	C	1	1.5	mJ
E _{off}	Turn-Of	f Switching Loss				0.52	0.78	mJ
E _{ts}	Total Sv	vitching Loss				1.52	2.28	mJ
t _{d(on)}	Turn-Or	n Delay Time				20		ns
t _r	Rise Tir	ne				54		ns
t _{d(off)}	Turn-Of	f Delay Time		$V_{CC} = 400 \text{ V}, I_C = 40 \text{ A},$		131		ns
t _f	Fall Tim	Time		$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 125$		70		ns
	Turn-Or	n Switching Loss				1.1		mJ
		Constraint in the				0.78		mJ
E _{off}		f Switching Loss			+			
E _{off} E _{ts}	Total Sv	vitching Loss				1.88		mJ
E _{on} E _{off} E _{ts} Q _g Q _{ge}	Total Sv Total Ga	5		V _{CE} = 400 V, I _C = 40 A,		1.88 120 14		mJ nC nC

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FGH80
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600 \
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Stop IGB
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Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V _{FM} Diode Forward Vo	Diode Forward Voltage	I _F = 15 A	T _C = 25°C	-	1.2	1.5	V
			T _C = 125°C	-	1.0	-	
t _{rr}	Diode Reverse Recovery Time		T _C = 25°C	-	61	-	ns
٩r		I _F = 15 A,	T _C = 125°C	-	125	-	
I _{rr}	Diode Reverse Recovery Current		$T_{C} = 25^{\circ}C$	-	4.8	-	А
In Diodo Ite			T _C = 125°C	-	8.4	-	
Q _{rr} Diode Reverse Rec	Diode Reverse Recovery Charge		$T_{C} = 25^{\circ}C$	-	146	-	nC
			T _C = 125°C	-	525	-	

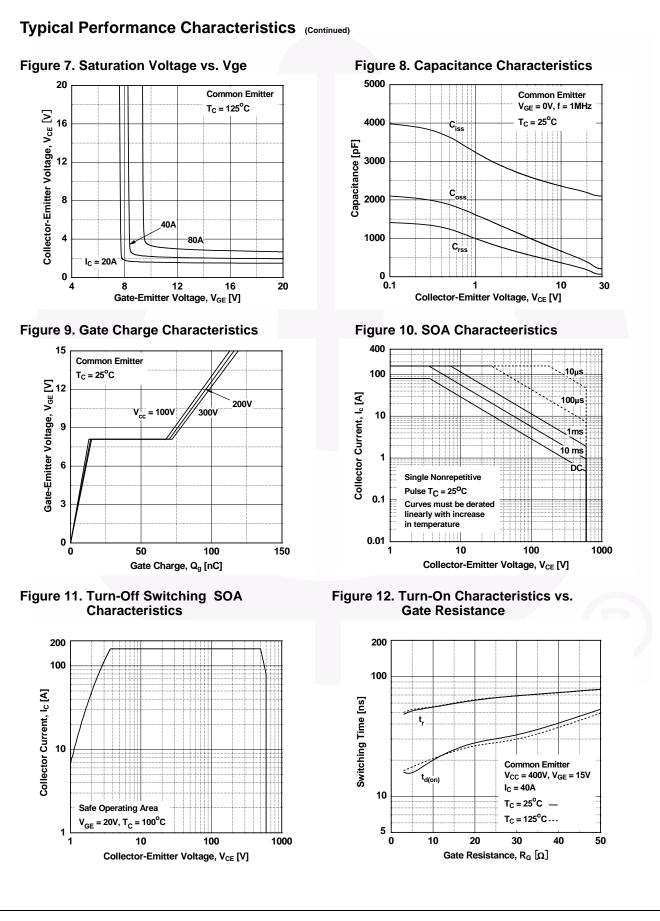
FGH80N60FD2 — 600 V Field Stop IGBT



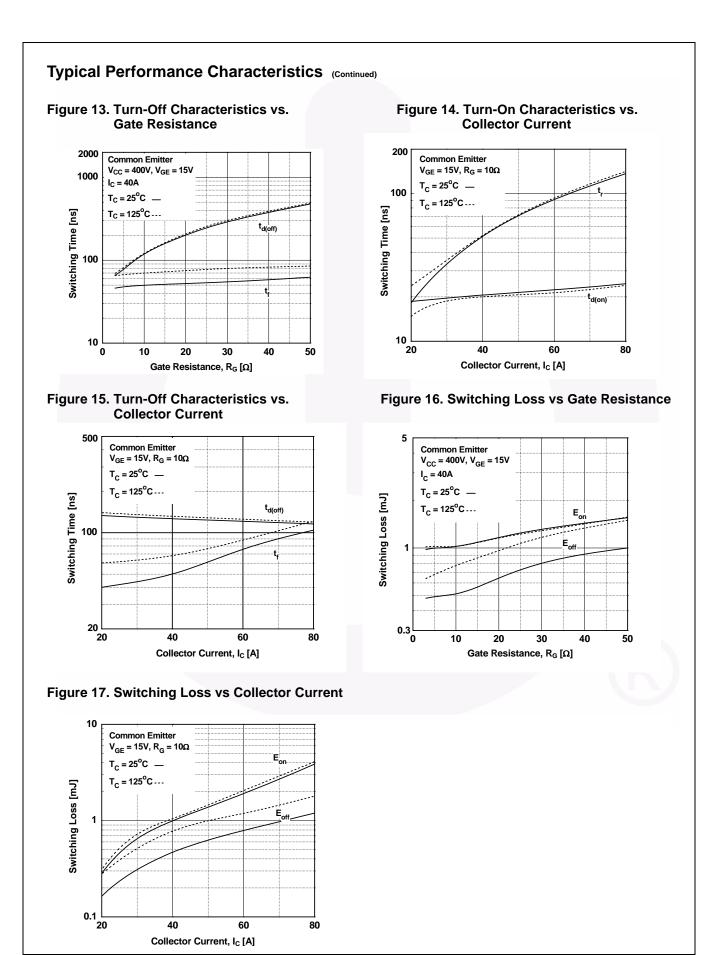
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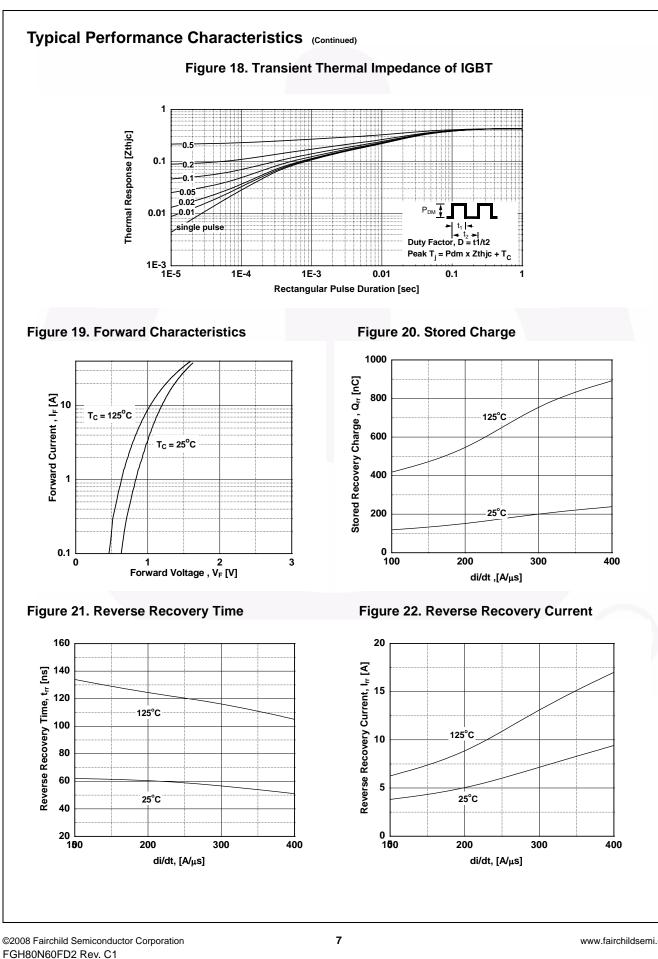
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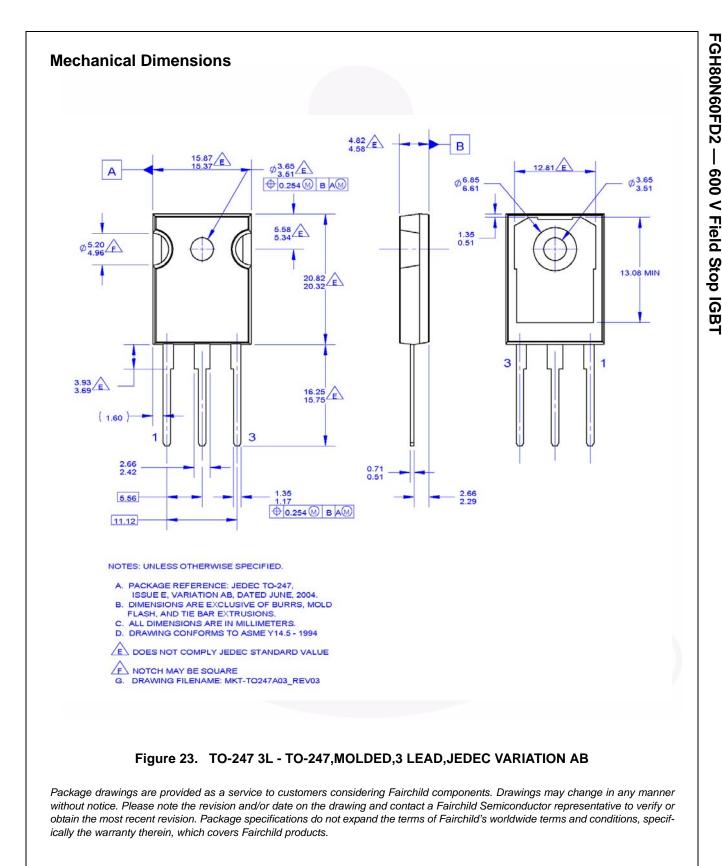
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FGH80N60FD2 —

600 V Field Stop IGBT

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